



Physical Interface & Carriers Japan TC Chapter

Japan Standards Winter Meetings 2024
Thursday, December 12, 2024

Room 702, International Conference Tower 7F, Tokyo Big Sight, Tokyo, Japan

in conjunction with SEMICON Japan / OVTCCM (Hybrid)
9:00 – 12:00 JST

AGENDA

1. **Welcome / Call to Order**
 - 1.1 Introductions
 - 1.2 Meeting Reminders (*Membership Requirement, Antitrust and Intellectual Property Reminders, Effective Meeting Guidelines*)
 - 1.3 Agenda Review

2. **Review of Previous Meeting Minutes**

3. **Liaison Report**
 - 3.1 North America

4. **Staff Report**

5. **Ballot Review**

#	When	TF	Details
7290	Cycle 8, 2024	Panel Level Packaging (PLP) Panel FOUP Task Force	Line Item Revision to SEMI E182-0424 - Specification for Panel FOUP Loadport for Panel Level Packaging

6. **Subcommittee & Task Force Reports**

- 6.1 Global PIC Standards Maintenance TF
- 6.2 Japan Electron Microscopy Workflow liaison TF
- 6.3 Panel Level Packaging Panel FOUP TF
- 6.4 Next Gen Assembly / Test Material Handling TF
- 6.5 [Liaison: 3D Packaging & Integration JA TCC] Panel Level Packaging Glass Carrier TF
- 6.6 [Liaison: 3D Packaging & Integration NA TCC] Panel Level Packaging Panel TF

7. **Old Business**

- 7.1 Project Period Review
- 7.2 5 Year Review

8. **New Business**

9. Action Item Review

9.1 Open Action Items

#	Assigned to	Details
PIC_20240902-01	SEMI Staff	There is concerned that not many people will be able to attend the Global Standards Summit (GSS) all day. One idea is that if it is possible to categorise each topic, that should be coordinated with the time of the Task Force. SEMI Japan staff will suggest to the GSS Preparatory team.
PIC_20240902-02	SEMI Staff	Semi Japan staff will Obtain the PIP document and request for the PIP document and approval to the Publication Manager and PIC TC Co-chair.
PIC_20240902-03	Komatsu san	There is reported that sometimes no Roster in the TF meeting. Shoji Komatsu will notice the appropriate operations to TF leaders in the next meeting.

9.2 New Action Items

#	Assigned to	Details

10. Next Meeting and Adjournment